Silicon N Channel MOS FET High Speed Power Switching

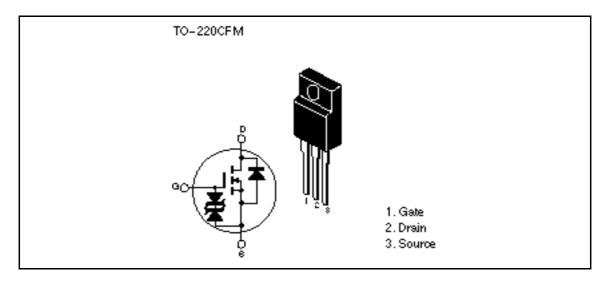


ADE-208-483 1st. Edition

Features

- Low on-resistance
 - $R_{DS} = 15 \text{ m}$ typ
- High speed switching
- 4V gate drive device can be driven from 5V source

Outline





Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Ratings	Unit				
Drain to source voltage	V _{DSS}	60	V				
Gate to source voltage	V _{GSS}	±20	V				
Drain current	I _D	40	А				
Drain peak current	↓ D(pulse) *1	160	А				
Body to drain diode reverse drain current	I _{DR}	40	А				
Avalanche current	l _{AP} * ³	40	А				
Avalanche Energy	E _{AR} * ³	137	mJ				
Channel dissipation	Pch*2	30	W				
Channel temperature	Tch	150	°C				
Storage temperature	Tstg	-55 to +150	°C				
Notoo: 1 DW 10up duty pyclo 19/							

Notes: 1. PW 10 μ s, duty cycle 1 %

2. Value at Tc = 25°C

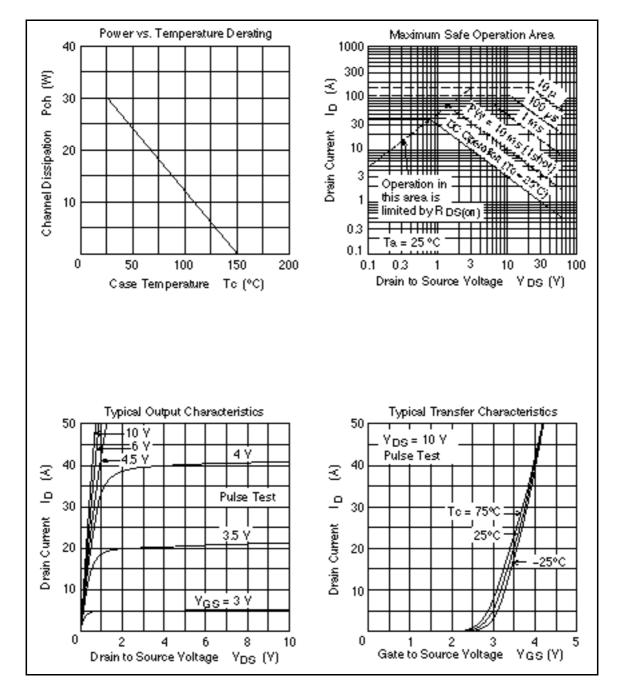
3. Value at Tch = 25° C, Rg 50

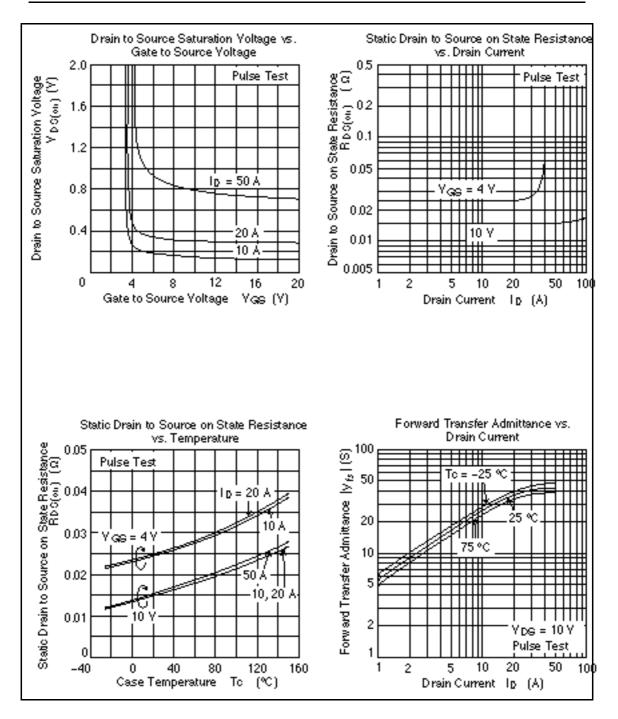
Electrical Characteristics (Ta = 25°C)

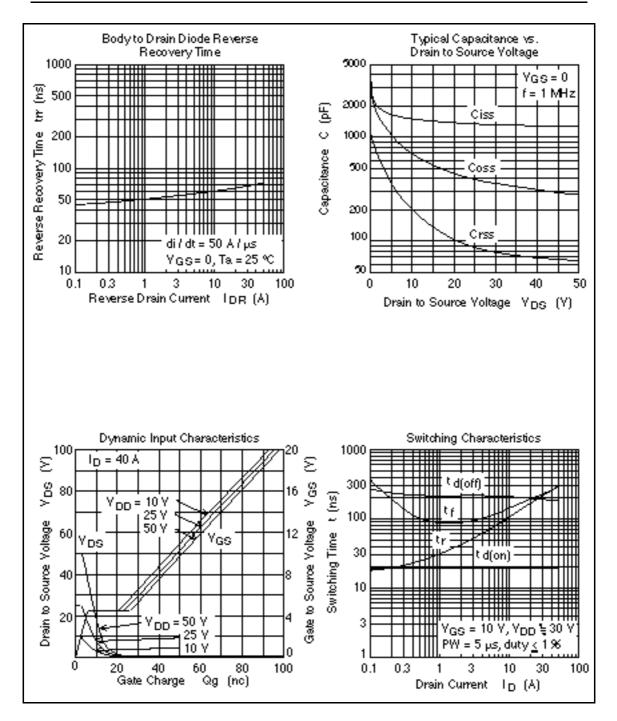
Item	Symbol	Min	Тур	Мах	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(\text{BR})\text{DSS}}$	60	_	_	V	$I_{\rm D} = 10 {\rm mA}, V_{\rm GS} = 0$
Gate to source breakdown voltage	$V_{(\text{BR})\text{GSS}}$	±20	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μA	$V_{GS} = \pm 16V, V_{DS} = 0$
Zero gate voltege drain current	I _{DSS}	_	_	10	μA	$V_{\rm DS} = 60 \ V, \ V_{\rm GS} = 0$
Gate to source cutoff voltage	$V_{\text{GS(off)}}$	1.5	_	2.5	V	$I_{\rm D} = 1$ mA, $V_{\rm DS} = 10$ V
Static drain to source on state	$R_{\text{DS(on)}}$	_	15	20	m	$I_{\rm D} = 20$ A, $V_{\rm GS} = 10$ V ^{*1}
resistance	R _{DS(on)}	_	25	40	m	$I_{\rm D} = 20$ A, $V_{\rm GS} = 4$ V ^{*1}
Forward transfer admittance	y _{fs}	20	35		S	$I_{\rm D} = 20$ A, $V_{\rm DS} = 10$ V ^{*1}
Input capacitance	Ciss	_	1500	_	pF	$V_{DS} = 10V$
Output capacitance	Coss	_	720	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	200	_	pF	f = 1MHz
Turn-on delay time	t _{d(on)}	—	20		ns	$I_{\rm D} = 20$ A, $V_{\rm GS} = 10$ V
Rise time	t,	_	180	_	ns	R _L = 1.5
Turn-off delay time	$t_{d(off)}$	_	200		ns	_
Fall time	t _f	—	200		ns	
Body to drain diode forward voltage	VDF	_	0.95	_	V	$I_F = 40A$, $V_{GS} = 0$ diF/ dt = 50A/µs
Body to drain diode reverse recovery time	t _{rr}		70	_	V	$I_F = 40A$, $V_{GS} = 0$ $di_F/ dt = 50A/\mu s$
Noto: 1 Pulso tost						

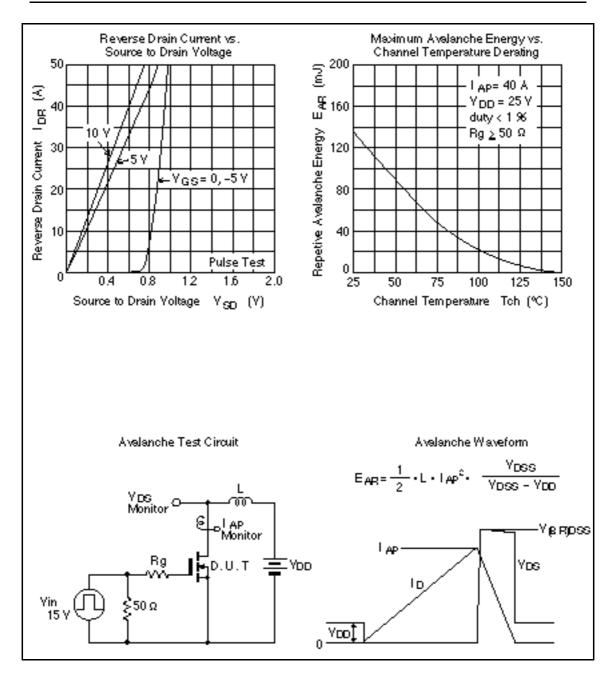
Note: 1. Pulse test

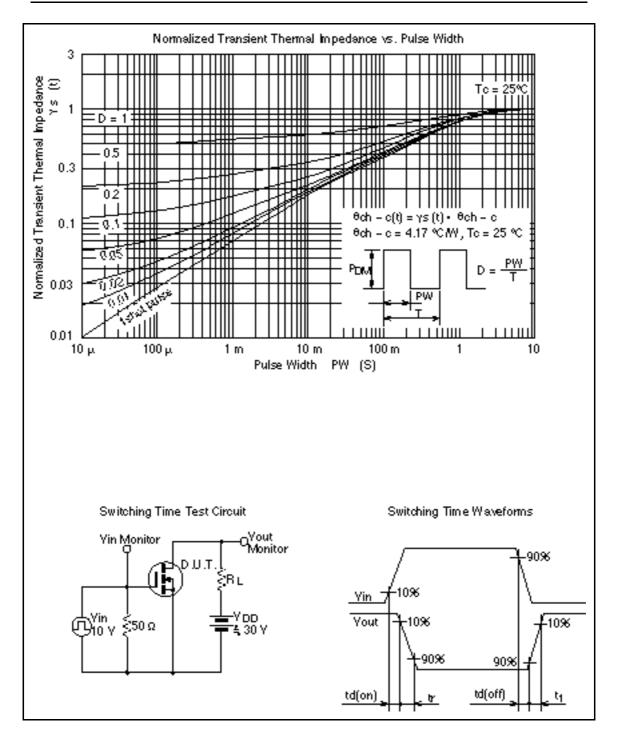
Main Characteristics





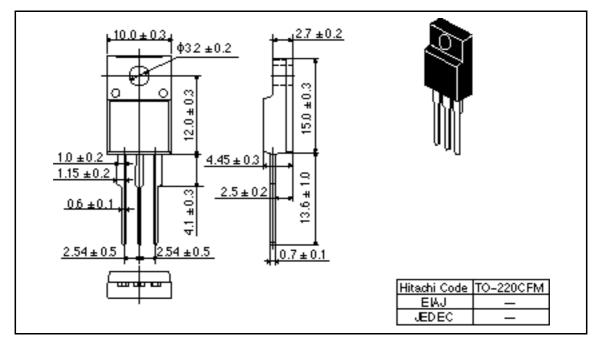






Package Dimensions





When using this document, keep the following in mind:

- 1. This document may, wholly or partially, be subject to change without notice.
- 2. All rights are reserved: No one is permitted to reproduce or duplicate, in any form, the whole or part of this document without Hitachi's permission.
- 3. Hitachi will not be held responsible for any damage to the user that may result from accidents or any other reasons during operation of the user's unit according to this document.
- 4. Circuitry and other examples described herein are meant merely to indicate the characteristics and performance of Hitachi's semiconductor products. Hitachi assumes no responsibility for any intellectual property claims or other problems that may result from applications based on the examples described herein.
- 5. No license is granted by implication or otherwise under any patents or other rights of any third party or Hitachi, Ltd.
- 6. MEDICAL APPLICATIONS: Hitachi's products are not authorized for use in MEDICAL APPLICATIONS without the written consent of the appropriate officer of Hitachi's sales company. Such use includes, but is not limited to, use in life support systems. Buyers of Hitachi's products are requested to notify the relevant Hitachi sales offices when planning to use the products in MEDICAL APPLICATIONS.

HITACHI

Hitachi, Ltd.

Semiconductor & IC Div. Neppon Bidg, 2-5-2, Ohte-mach, Chiyoda-ku, Tokyo 100, Japan Tet Tokyo (03, 3270-2111 Fax (03, 3270-5109

For Auther in forms Ion write to : Hischi America, Ud Semiconductor & IC DV. 2000 Sierre Point Perkway Briebena, CA. 94005-4835 U S.Å Tet 415-583-8300 Fax 415-583-4207

Hitschi Burope GmbH Bectronic Components Group Catilinentel Burope Damecher Straße 3 D-85622 Feldkirchen Minchen Tet 089-9 94 80-0 Fex: 089-9 29 30 00 Hitschi Europe Ltd. Bectronic Components Div. Northern Burge Hesdguerters Whitebrook Park Lower Cook hem Roed Meidenhesd Berkshire SL68YA Urited Kingdom Tet 0628-385000 Fex 0628-778222 Hitschi Asia Pta. Ltd 45 Collyer Quay \$20-00 Hitschi Towar Singspore 0404 Tet 535-2400 Fax 535-4533

Hitschi Asia (Hong Kong) Ltd. Unit 705, North Towar, World Finance Cantre, Herbour City, Carton Road Taim Sha Tau, Kowloon Hong Kong Tet 27350218 Fax: 27350218